## LSF0102

2-bit bidirectional multi-voltage level translator; open-drain; push-pull

Rev. 3 — 4 September 2020

**Product data sheet** 

### 1. General description

The LSF0102 is a 2 channel bidirectional multi-voltage level translator for open-drain and push-pull applications. It supports up to 100 MHz up translation and  $\geq$ 100 MHz down translation at  $\leq$  30 pF capacitive load. There is no need for a direction pin which minimizes system effort. The LSF0102 supports 5 V tolerant I/O pins for compatibility with TTL levels in a variety of applications. The ability to set up different voltage translation levels on each channel makes the device very flexible and suitable for a lot of different applications.

### 2. Features and benefits

- Bidirectional voltage translation with no direction pin
- Up translation
  - ≤ 100 MHz; C<sub>L</sub> = 30 pF
  - ≤ 40 MHz; C<sub>L</sub> = 50 pF
- Down translation
- ≥ 100 MHz; C<sub>L</sub> = 30 pF
- ≤ 40 MHz; C<sub>L</sub> = 50 pF
- Hot insertion
- Bidirectional voltage level translation between:
  - 0.95 V and 1.8 V, 2.5 V, 3.3 V and 5.0 V
  - 1.2 V and 1.8 V, 2.5 V, 3.3 V and 5.0 V
  - 1.8 V and 2.5 V, 3.3 V and 5.0 V
  - 2.5 V and 3.3 V and 5.0 V
  - 3.3 V and 5.0 V
- Low standby current
- 5 V tolerant I/O pins to support TTL
- Low R<sub>ON</sub> provides less signal distortion
- High-impedance I/O pins for EN = Low.
- Flow-through pinout for easy PCB trace routing.
- Latch-up performance exceeds 100 mA per JESD78 class II level A
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2000 V
  - CDM ANSI/ESDA/JEDEC JS-002 Class C3 exceeds 1000 V
- Specified from -40 °C to +125 °C

### 3. Applications

- GPIO, MDIO, PMBus, SMBus, SDIO, UART, I<sup>2</sup>C, and other interfaces in Telecom infrastructure
- Industrial
- Personal computing

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### 4. Ordering information

#### Table 1. Ordering information

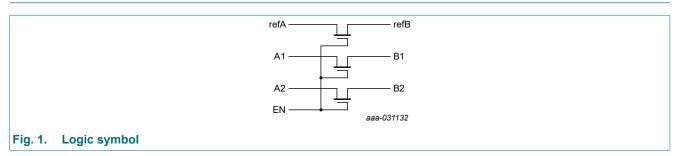
Type number	Package						
	Temperature range	Name	Description	Version			
LSF0102DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2			
LSF0102DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1			
LSF0102GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	SOT1203			
LSF0102GX	-40 °C to +125 °C	X2SON8	plastic thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.35 × 0.8 × 0.32 mm	SOT1233-2			

### 5. Marking

Table 2. Marking					
Type number	Marking code[1]				
LSF0102DP	h2				
LSF0102DC	h2				
LSF0102GS	h2				
LSF0102GX	h2				

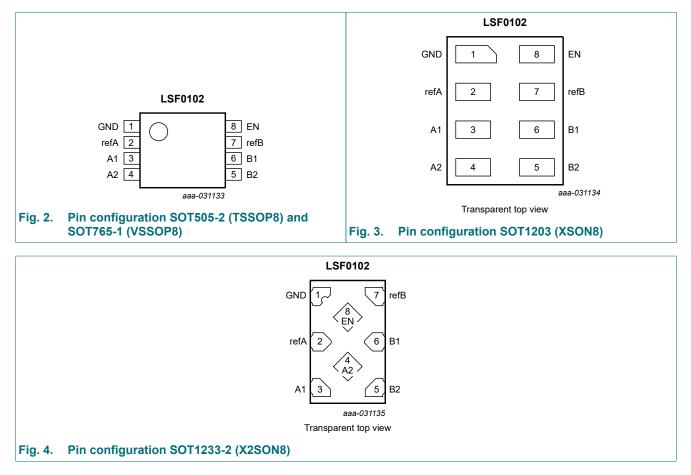
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

### 6. Functional diagram



### 7. Pinning information





### 7.2. Pin description

Table 3. Pin description						
Symbol	Pin	Description				
GND	1	ground (0 V)				
refA	2	reference voltage A				
A1, A2	3, 4	data input/output A				
B1, B2	6, 5	data input/output B				
refB	7	reference voltage B				
EN	8	enable input (active HIGH)				

### 8. Functional description

#### Table 4. Function table

*H* = HIGH voltage level; *L* = LOW voltage level; *Z* = high-impedance OFF-state.

Input	input/output
EN	An, Bn channel
Н	An = Bn
L	Z

### 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Мах	Unit
VI	input voltage	pins refA, refB, An, Bn and EN	[1]	-0.5	+7.0	V
I <sub>I/O</sub>	input/ouput current	pins refA, refB, An and Bn; continuous channel current		-	+128	mA
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] For SOT505-2 (TSSOP8) package: P<sub>tot</sub> derates linearly with 4.6 mW/K above 96 °C.
 For SOT765-1 (VSSOP8) package: P<sub>tot</sub> derates linearly with 4.9 mW/K above 99 °C.
 For SOT1203 (XSON8) package: P<sub>tot</sub> derates linearly with 3.6 mW/K above 81 °C.
 For SOT1233-2 (X2SON8) package: P<sub>tot</sub> derates linearly with 7.7 mW/K above 118 °C.

### 10. Recommended operating conditions

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage	pins refA, refB, An, Bn and EN	0.0	5.0	V
I <sub>I/O</sub>	input/ouput current	pins refA, refB, An and Bn; continuous channel current	-	+64	mA
T <sub>amb</sub>	ambient temperature		-40	+125	°C

### **11. Static characteristics**

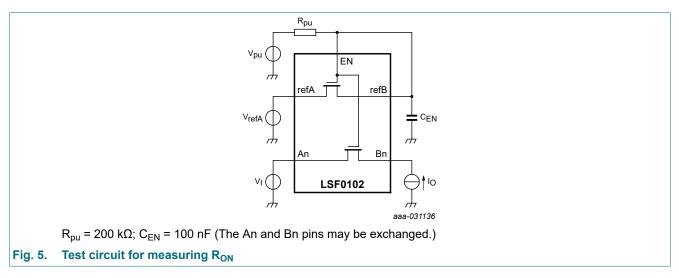
#### Table 7. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> =	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Мах	1
V <sub>IK</sub>	input clamping voltage	V <sub>EN</sub> = 0 V; I <sub>I</sub> = -18 mA	-1.2	-	-	V
l <sub>l</sub>	leakage current	pins An, Bn, refA, refB and EN; V <sub>I</sub> = GND to 5.0 V	-	1	5	μA
CI	input capacitance	pins refA, refB and EN; V <sub>I</sub> = 0 V or 3 V	-	6	-	pF
C <sub>io(off)</sub>	OFF-state input/output capacitance	pins An, Bn; V <sub>O</sub> = 0 V or 3 V; V <sub>EN</sub> = 0.0 V	-	3	6.0	pF
C <sub>io(on)</sub>	ON-state input/output capacitance	pins An, Bn; V <sub>O</sub> = 0 V or 3 V; V <sub>EN</sub> = 3.0 V	-	6	12.5	pF
R <sub>ON</sub>	ON resistance	see <u>Fig. 5</u> [2]				
		V <sub>I</sub> = 0 V; V <sub>pu</sub> = 5.0 V; I <sub>O</sub> = 64 mA				
		V <sub>refA</sub> = 3.3 V	-	3	-	Ω
		V <sub>refA</sub> = 1.8 V	-	4	-	Ω
		V <sub>refA</sub> = 1.0 V	-	7	-	Ω
		V <sub>I</sub> = 0 V; V <sub>pu</sub> = 5.0 V; I <sub>O</sub> = 32mA				
		V <sub>refA</sub> = 1.8 V	-	4	-	Ω
		V <sub>refA</sub> = 2.5 V	-	3	-	Ω
		V <sub>I</sub> = 1.8 V; V <sub>pu</sub> = 5.0 V; I <sub>O</sub> = 15 mA				
		V <sub>refA</sub> = 3.3 V	-	4	-	Ω
		V <sub>I</sub> = 1.0 V; V <sub>pu</sub> = 3.3 V; I <sub>O</sub> = 10 mA				
		V <sub>refA</sub> = 1.8 V	-	7	-	Ω
		V <sub>I</sub> = 0 V; V <sub>pu</sub> = 3.3 V; I <sub>O</sub> = 10 mA				
		V <sub>refA</sub> = 1.0 V	-	5	-	Ω
		V <sub>I</sub> = 0 V; V <sub>pu</sub> = 1.8 V; I <sub>O</sub> = 10 mA				
		V <sub>refA</sub> = 1.0 V	-	6	-	Ω

[1] All typical values are measured at  $T_{amb}$  = 25 °C.

[2] Measured by the voltage drop between the An and Bn pins at the indicated current through the switch. ON resistance is determined by the lowest voltage of the two (An or Bn) pins.



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### **12. Dynamic characteristics**

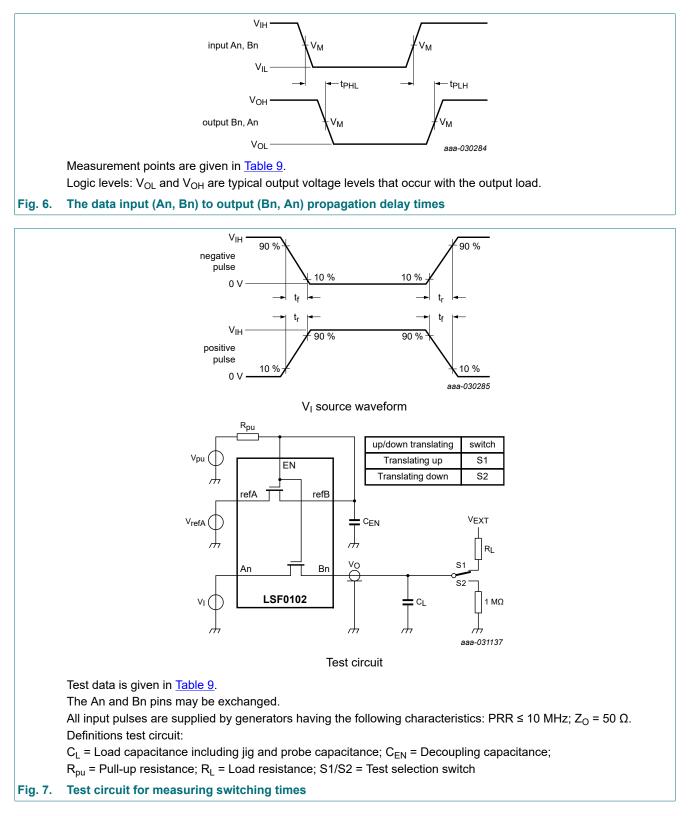
#### Table 8. Switching characteristics

GND = 0 V; for waveform see Fig. 6; for test circuit see Fig. 7

Symbol	Parameter	Conditions	T <sub>amb</sub>	= -40 °C to +′	125 °C	Unit
			Min Typ[1]		Max	
Translat	ing down		I			
t <sub>PLH</sub>	LOW to HIGH	An to Bn or Bn to An;				
	propagation delay	V <sub>IH</sub> = V <sub>pu</sub> = V <sub>refA</sub> + 1 V				
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 15 pF	-	0.35	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 30 pF	-	0.8	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 50 pF	-	1.2	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 15 pF	-	0.3	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 30 pF	-	0.7	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 50 pF	-	1.1	-	ns
t <sub>PHL</sub>	HIGH to LOW	An to Bn or Bn to An;				
	propagation delay	V <sub>IH</sub> = V <sub>pu</sub> = V <sub>refA</sub> + 1 V				
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 15 pF	-	0.5	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 30 pF	-	1.0	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 50 pF	-	1.3	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 15 pF	-	0.4	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 30 pF	-	0.8	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 50 pF	-	1.2	-	ns
Translat	ing up		I			_
t <sub>PLH</sub>	LOW to HIGH	An to Bn or Bn to An;				
	propagation delay	V <sub>IH</sub> = V <sub>refA</sub> ; V <sub>EXT</sub> = V <sub>pu</sub> = V <sub>refA</sub> + 1 V				
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 15 pF	-	0.5	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 30 pF	-	0.9	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 50 pF	-	1.1	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 15 pF	-	0.4	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 30 pF	-	0.8	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 50 pF	-	1.0	-	ns
t <sub>PHL</sub>	HIGH to LOW	An to Bn or Bn to An;				
	propagation delay	V <sub>IH</sub> = V <sub>refA</sub> ; V <sub>EXT</sub> = V <sub>pu</sub> = V <sub>refA</sub> + 1 V				
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 15 pF	-	0.6	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 30 pF	-	1.1	-	ns
		V <sub>refA</sub> = 1.5 V; C <sub>L</sub> = 50 pF	-	1.3	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 15 pF	-	0.4	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 30 pF	-	0.9	-	ns
		V <sub>refA</sub> = 2.3 V; C <sub>L</sub> = 50 pF	-	1.0	-	ns

[1] All typical values are measured at  $T_{amb}$  = 25 °C.

### 12.1. Waveforms and test circuit



#### Table 9. Test data

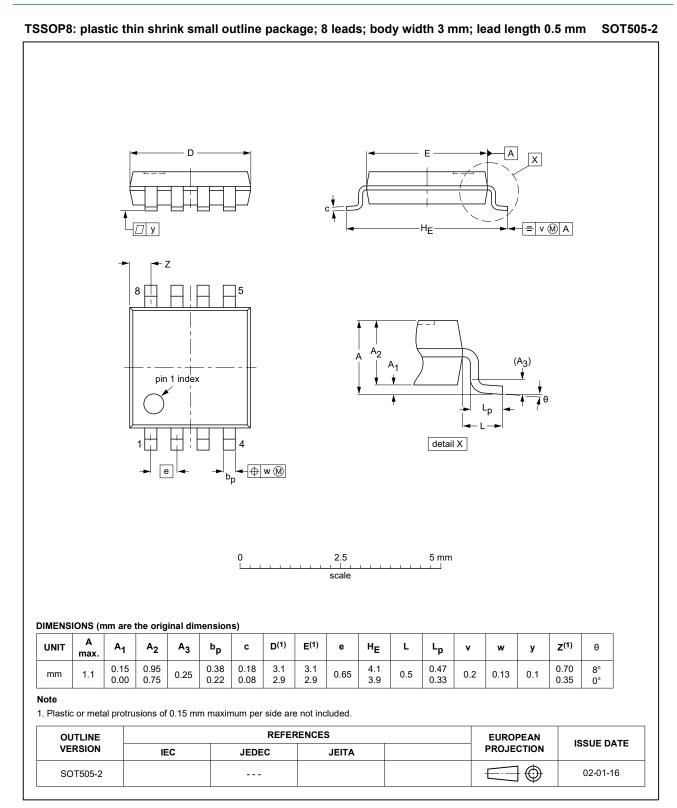
Input		Output	Load			
t <sub>r</sub> , t <sub>f</sub>	V <sub>M</sub>	V <sub>M</sub>	CL	C <sub>EN</sub> [1]	R <sub>L</sub> [1]	R <sub>pu</sub>
≤ 2 ns	0.5V <sub>refA</sub>	0.5V <sub>refA</sub>	15 pF, 30 pF, 50 pF	100 nF	300 Ω	200 kΩ

[1] All typical values are measured at  $T_{amb}$  = 25 °C.

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### 13. Package outline

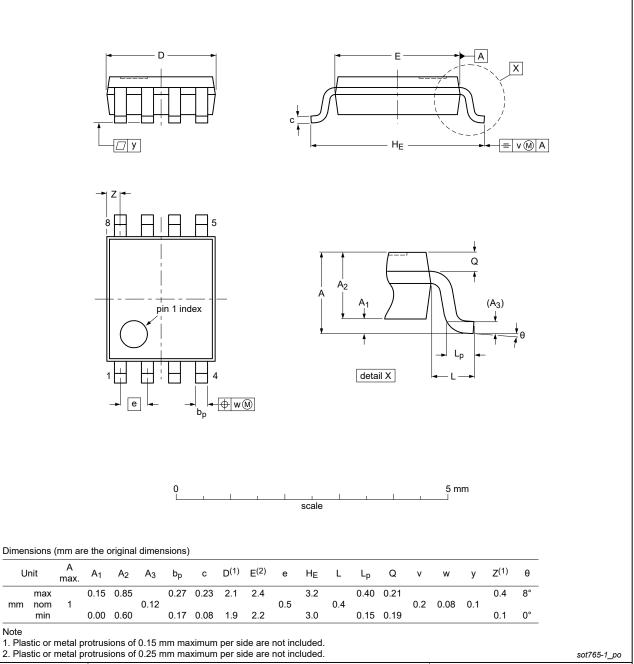


#### Fig. 8. Package outline SOT505-2 (TSSOP8)

SOT765-1

#### 2-bit bidirectional multi-voltage level translator; open-drain; push-pull

#### VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm



Outline		Refer	ences	European	Issue date
version	IEC	JEDEC	JEITA	projection	issue date
SOT765-1		MO-187			<del>- 07-06-02</del> 16-05-31



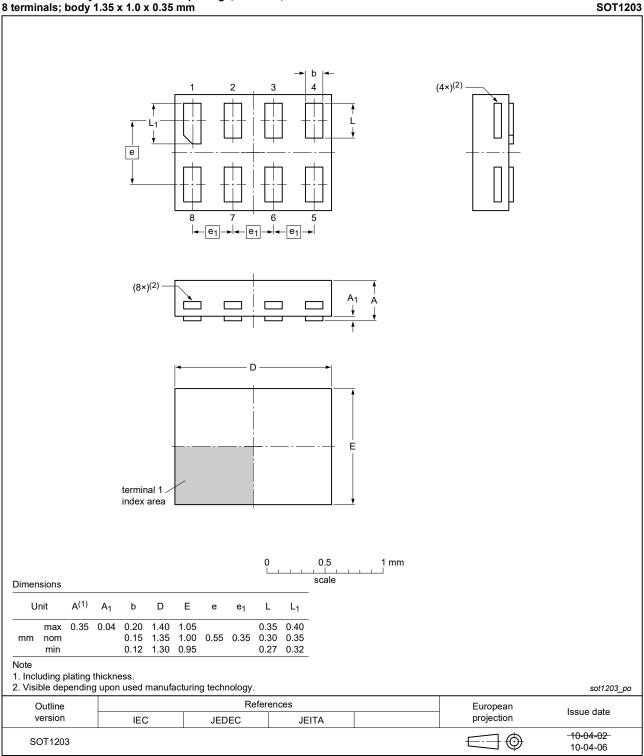
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**Product data sheet** 

mm

Note

XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm





### **LSF0102**

#### 2-bit bidirectional multi-voltage level translator; open-drain; push-pull

X2SON8: plastic thermal enhanced extremely thin small outline package; no leads;

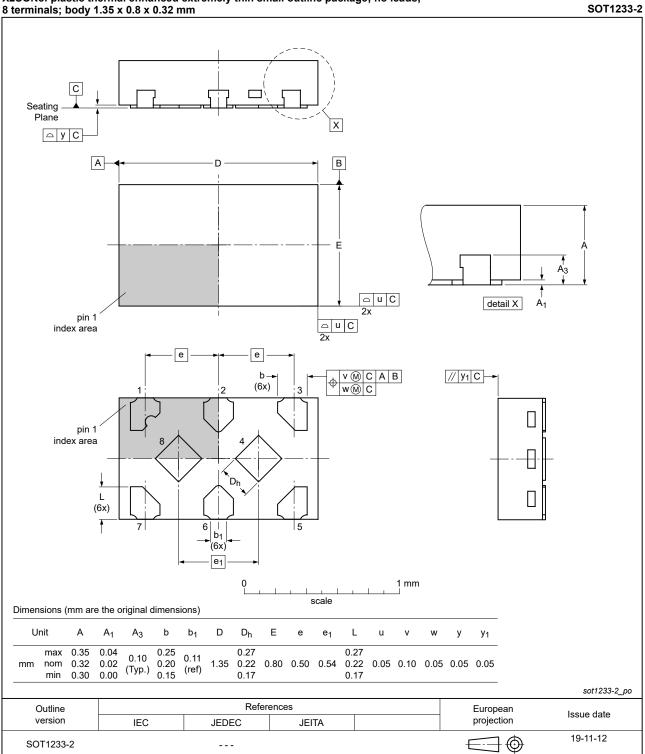


Fig. 11. Package outline SOT1233-2 (X2SON8)

### 14. Abbreviations

Table 10. Abbreviations					
Acronym	Description				
CDM	Charged Device Model				
ESD	ElectroStatic Discharge				
НВМ	Human Body Model				
TTL	Transistor-Transistor Logic				

### 15. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
LSF0102 v.3	20200904	Product data sheet	-	LSF0102 v.2		
Modifications:	Type number LSF0102DC (SOT765-1/VSSOP8) added.					
LSF0102 v.2	20200818	Product data sheet	-	LSF0102 v.1		
Modifications:	<ul> <li>LSF0102GS (SOT1203/XSON8) and LSF0102GX (SOT1233-2/X2SON8) are in production. Removed note from <u>ordering information</u>.</li> <li>Type number LSF0102DC (SOT765-1/VSSOP8) is in development and removed from this product data sheet. A preliminary data sheet is available upon request.</li> </ul>					
LSF0102 v.1	20200414	Product data sheet	-	-		

### 16. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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